

Antenna YC0001AA Datasheet

Antenna Services

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About the Document

Revision History

Version	Date	Author	Note
1.0	2020-05-28	Kenny YIN	Initial
2.0	2020-06-22	Kenny YIN	Updated the specifications.
2.1	2020-12-11	Kenny YIN	Updated the antenna image in Chapter 2.



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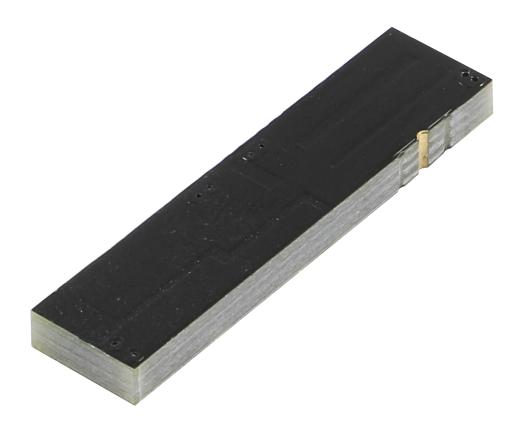
1 Product Description

The antenna is designed for superior performance, and can be widely used for wireless applications.

We provide comprehensive antenna design support such as simulation, testing and manufacturing for custom antenna solutions to meet your specific application needs.

2 Product Features

- Cellular LTE
- High efficiency
- Excellent performance





3 Product Specifications

Passive Electrical Specifications				
Frequency Range (MHz)	698–960, 1710–2690			
Input Impendence (Ω)	50			
VSWR	≤ 4.0			
Gain (dBi)	≤ 3.0			
Polarization Type	Linear			
Mechanical Specifications				
Antenna Size (mm)	35.0 (L) × 8.5 (W) × 3.0 (H)			
carrier	FR4			
Radiator	Cuprum			
Connect Type	/			
Working Temperature (°C)	- 40 to +85			
Radome Color	Black			



4 Overall Performance

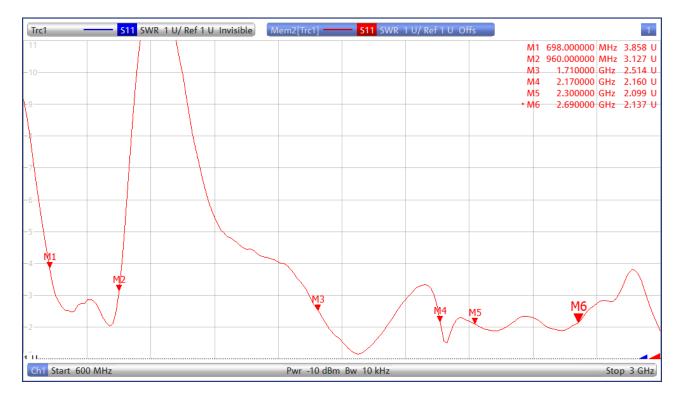
4.1. Performance

- Test Environment
 - KEYSIGHT VNA Network Analyzer E5063A 100 kHz 6.5 GHz.
 - RayZone[®] 2800 Chamber 5G (FR1) SISO/MIMO, 400 MHz 6.0 GHz.



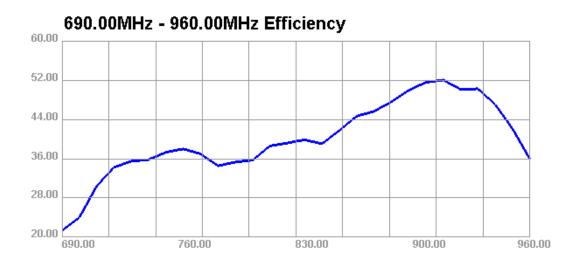


• VSWR

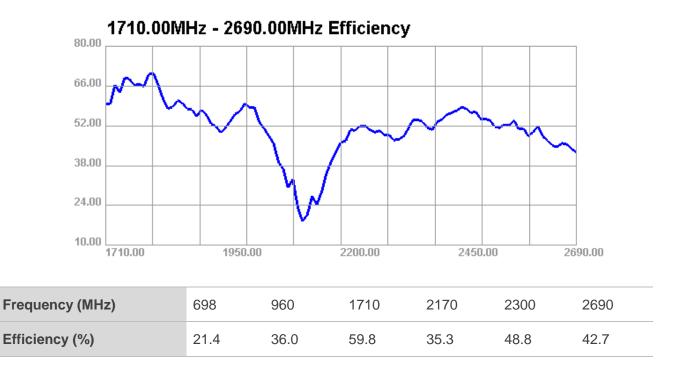


Frequency (MHz)	698	960	1710	2170	2300	2690
VSWR	3.85	3.12	2.51	2.16	2.09	2.13

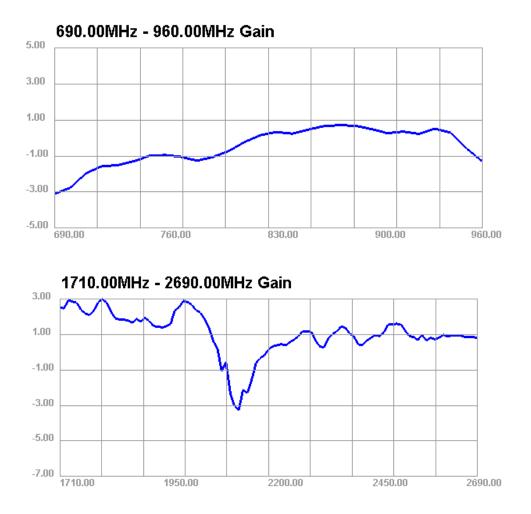
Efficiency







Gain

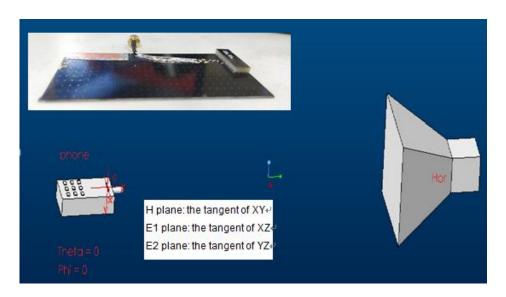


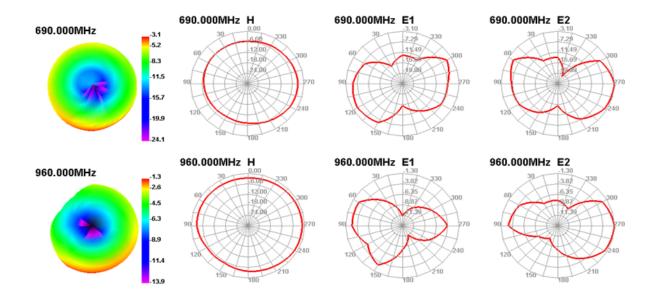


Frequency (MHz)	698	960	1710	2170	2300	2690
Gain	-2.73	-1.20	1.97	-1.54	1.33	0.95

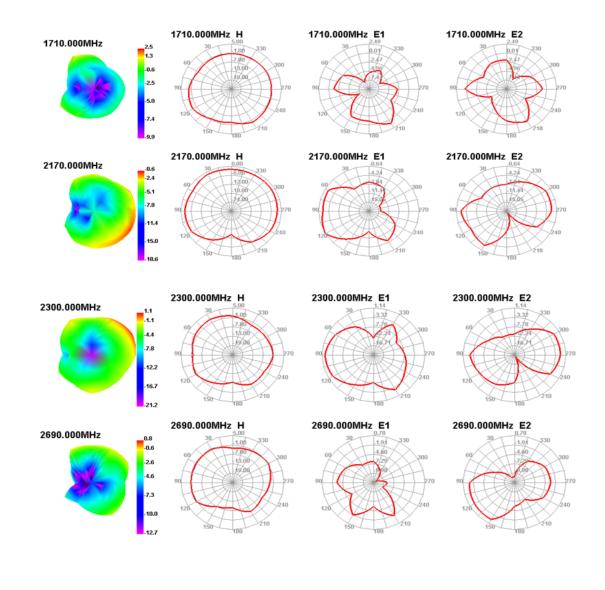
Radiation Patterns

Board length 110 mm





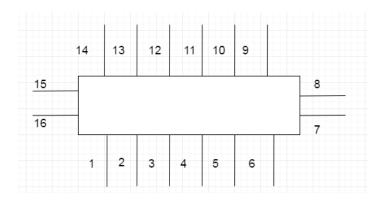






4.2. Schematic Symbol and Pin Definition

The pin assignment for the antenna are as follows. The antenna has 16 pins and only two work. All other pins are designed for mechanical strength.



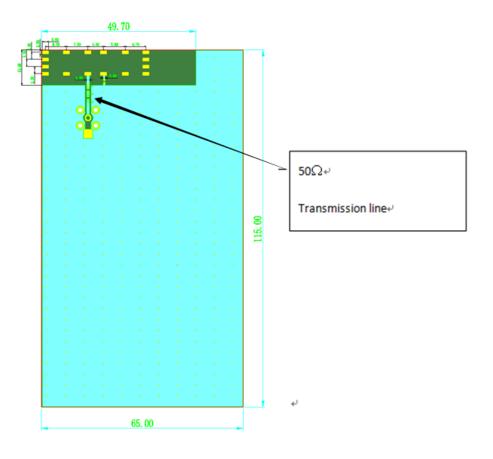
Pin No.	Description
3	Feed
4	Return/GND
1, 2, 5, 6, 7, 8, 9, 10, 11, 12, 13, 14, 15, 16	Not used (Mechanical only)



4.3. Transmission Line

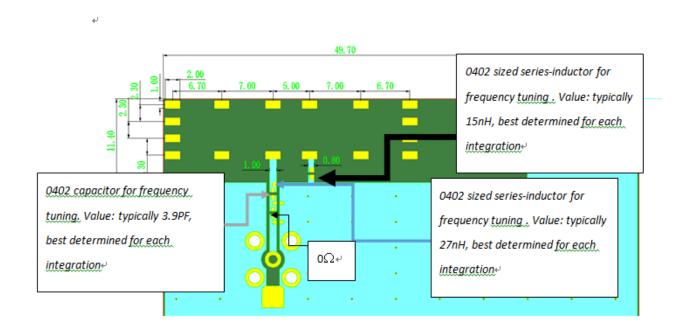
The characteristic impedance of all transmission lines shall be designed as 50 Ω .

- The length of the transmission lines should be kept to as short as possible
- Any other part of the RF system, such as transceiver, power amplifiers, etc., shall also be designed with an impedance of 50 Ω.

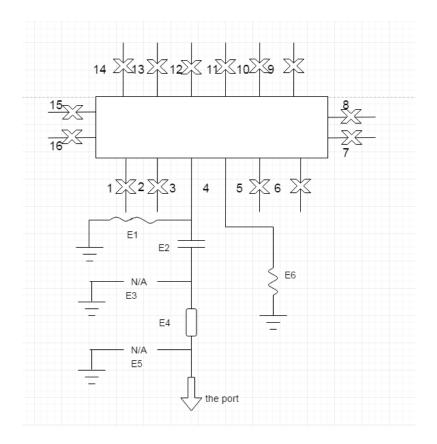




4.4. Matching Circuit



The antenna requires a matching circuit that must be optimized for each product. The matching circuit will require up to six components and the following circuit should be designed into the host PCB. Not all components may be required but should be included as a precaution. The matching network must be placed close to the antenna feed to ensure it is more effective in tuning the antenna.



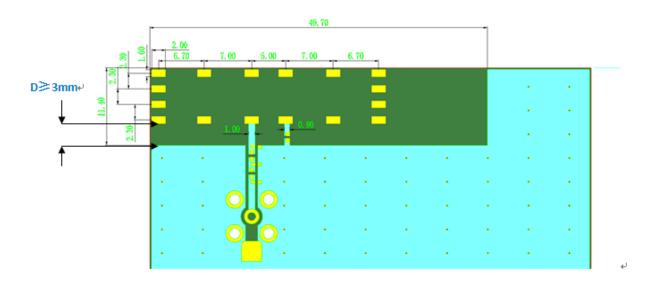


	Туре	Value
E1	Inductor	27 nH
E2	Capacitor	3.9 pF
E3	N/A	N/A
E4	Capacitance	0 Ω
E5	N/A	N/A
E6	Inductor	<i>15</i> nH

4.5. Host PCB Requirement

The printed circuit board of the host must ensure that the antenna clearance area meets the antenna specifications. It is suggested that putting the antenna in the corner of the PCB.

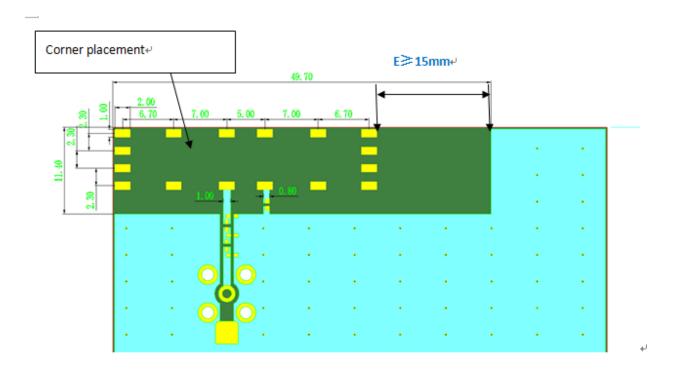
An example of a PCB layout shown as below:



Gap D is required from the edge of the antenna to the ground plane. This should be maintained along the edge of the antenna placement, **minimum value is 3 mm**.

Gap E is required from the edge of the antenna to the ground plane or PCB traces, **minimum value is 15 mm.**

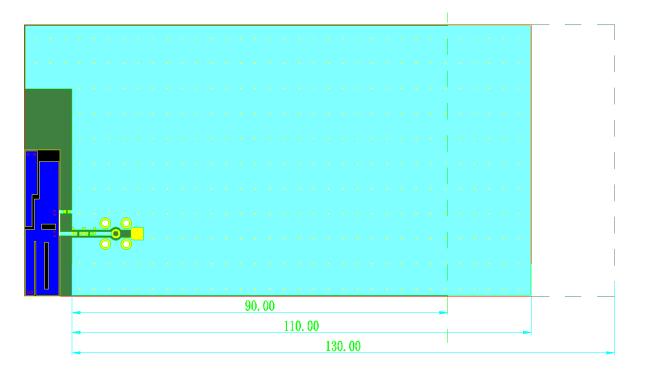


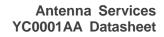


4.6. Host PCB Size

The performance of the low frequency section depends on the length of the ground plane. Reducing GND length will directly impact on the performance of low frequency band.

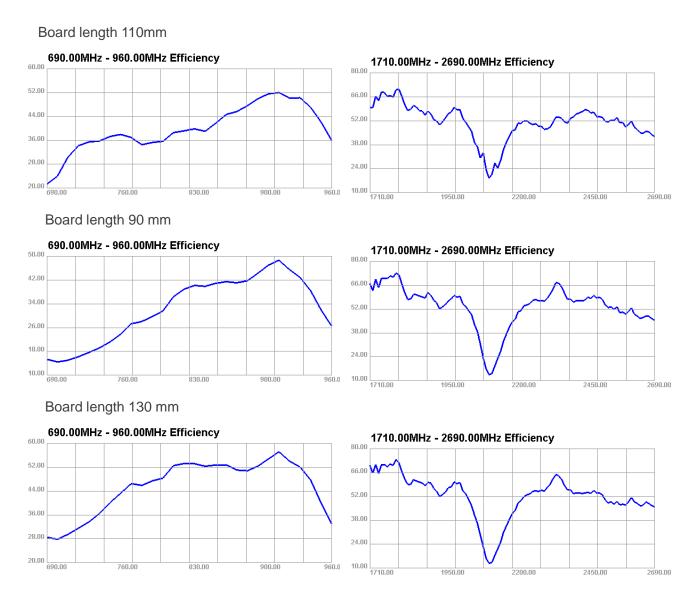
Take antenna efficiency measurement results on different GND sizes as an example:





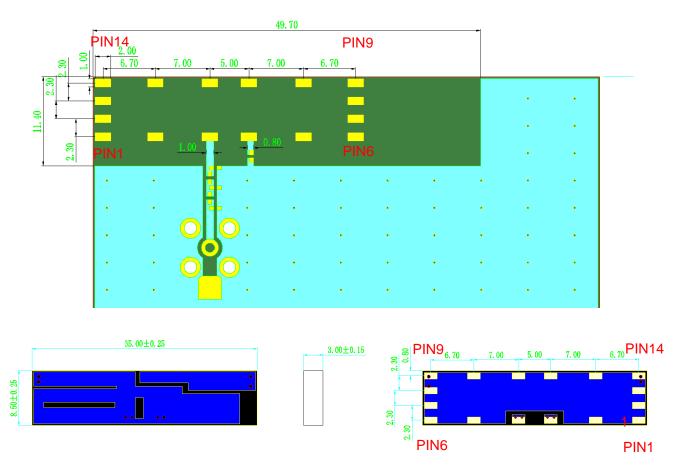


Passive Efficiency vs. PCB length All results measured in Quectel's anechoic chamber





5 Product Size



Please contact us for any unmarked size information.

6 Soldering Temperature

Phase	Profile Features	PB-Free Assembly (Max.)	
RAMP-UP	Avg. Ramp-up Rate (Tsmax to Tp)	3 °C/second (max.)	
	Temperature Min (Tsmin)	150 °C	
PREHEAT	Temperature Max (Tsmax)	180 °C	
	Time (TSmin to Tsmax)	120 seconds max.	
REFLOW	Temperature (TL)	210 °C	
REFLOW	Total Time above TL(tl)	50 seconds max.	
PFAK	Temperature (Tp)	260 °C	
FLAN	Time (tp)	10 seconds max.	
RAMP-DOWN	Rate	5 °C/second max	



7 Reflow Profile

